Temperature Input Modules

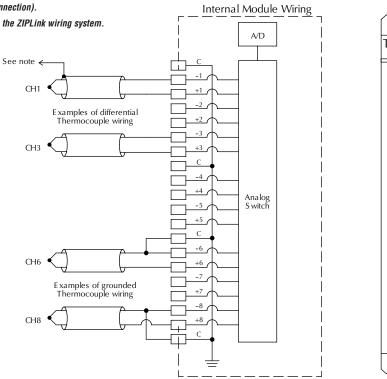
F3-08THM-J 8-Channel Thermocouple Input		Converter Type	Successive approximation, AD574
F3-08THM-K 8-Ch	annel Thermocouple Input	Linearity Error	±1 count (0.03% of full scale) maximum
	le, replace the "n" with the type of thermocouple a Type J thermocouple module, order part number	Maximum Inaccuracy at 77°F (25°C)	0.35% of full scale
F3-08THM-J; J is a stock item.		Accuracy vs. Temperature	57ppm/°C maximum full scale
Innut Donneo	Type J: -210/760°C, -350/1390°F -1: 0–50 mV -2: 0–100 mV	Power Budget Requirement	50mA @ 9VDC, 34mA @ 24VDC
Input Ranges		External Power Supply	None required
Resolution	12 bit (1 in 4096)	Operating Temperature	32° to 140°F (0° to 60°C)
Input Impedance	27K ohm DC	Storage Temperature	-4° to 158°F (-20° to 70°C)
Absolute Maximum	Fault protected input, 130 Vrms or 100VDC	Relative Humidity	5 to 95% (non-condensing)
Ratings		Environmental Air	No corrosive gases permitted
Cold Junction Compensation	Automatic	Vibration	MIL STD 810C 514.2
Compensation	15ms per channel, minimum 1 channel per CPU scan	Shock	MIL STD 810C 516.2
Conversion Time		Noise Immunity	NEMA ICS3-304

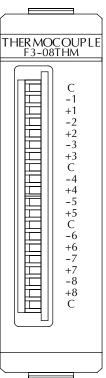
Notes:

1. Terminate shields at the respective signal source.

2. Leave unused channel open (no connection).

3. This module is not compatible with the ZIPLink wiring system.





Power Budget

Managing your power resource

The I/O configuration depends on your choice of I/O modules, bases and I/O location. When determining the types and quantity of I/O modules you will be using, it's important to remember there is a limited amount of power available from the power supply.

The chart on the next page indicates the power supplied and used by each DL305 device. The adjacent chart shows an example of how to calculate the power used by your particular system. These two charts should make it easy for you to determine if the devices you have chosen fit within the power budget of your system configuration.

If the I/O you have chosen exceeds the maximum power available from the power supply, you can resolve the problem by shifting some of the modules to an expansion base.

Use **ZIP**Links to reduce power requirements

If your application requires a lot of relay outputs, consider using the *ZIP*Link AC or DC relay output modules. These modules can switch high current (10A) loads without putting a load on your base power budget. Refer to the Wiring Solutions section in this catalog for more information.

This logo is placed next to I/O modules that are supported by the *ZIP*Link connection systems. See the I/O module specifications at the end of this section.



WARNING: It is extremely important to calculate the power budget correctly. If you exceed the power budget, the system may operate in an unpredictable manner, which may result in a risk of personal injury or equipment damage.

Example: How to calculate your power usage

The following example shows how to calculate the power budget for the DL305 system. The examples are constructed around a single 5-slot base using the devices shown. It is recommended you construct a similar table for each base in your DL305 system.

- 1. Using a chart similar to the one below, fill in column 2.
- 2. Using the tables on the opposite page, enter the current supplied and used by each device (columns 3, 4, and 5). Devices which fall into the "Other" category (Row D) are devices such as the Handheld Programmer or a Data Communication Unit, which also have power requirements, but do not directly plug into the base.

- 3. Add the current used by the system devices (columns 3, 4, and 5), starting with Slot 1, then put the total in the row labeled "Maximum Current Required" (Row E).
- 4. Subtract the row labeled "Maximum Current Required" (Row E), from the row labeled "Current Supplied" (Row B). Place the difference in the row labeled "Remaining Current" (Row F).
- 5. If "Maximum Current Required" is greater than "Current Supplied" in columns 3, 4 or 5, the power budget will be exceeded. It will be unsafe to use this configuration and you will need to restructure your I/O configuration.

A	Column 1	Column 2	Column 3	Column 4	Column 5		
	Base # 0	Device Type	5 VDC (mA)	9VDC (mA)	24V(mA)		
B	^B Current Supplied						
	5-slot Base	D3-05BDC	1400	800	500		
С	Current Required						
	CPU Slot	D3-330	300	50	0		
	Slot 0	D3-16NE3	0	130	0		
	Slot 1	D3-16NE3	0	130	0		
	Slot 2	D3-08TA-1	0	160	0		
	Slot 3	D3-08TA-1	0	160	0		
D	D Other						
	Handheld prog D3-HPP*		50	50	0		
E	E Maximum Current Required		350	630	0		
F	F Remaining Current		1050	170	500		

*Note: D3-HPP is discontinued as of 06/2021.

DL305 Power Requirements

This section shows the amount of power supplied by the base power supplies and the amount of power used by each DL305 device. Note the base power supplies provide three internal voltages (5V, 9V, 24V). The chart shows how much power from each of these power sources is required for each DL305 device. Use this information when calculating the power budget for your system.

In addition to the three internal power sources, the DL305 bases provide an external power connection. There is 24VDC available from the 24VDC output terminals on the bases (except D3-05BDC and D3-10BDC).

The 24VDC can be used to power external devices or DL305 modules that require external 24VDC. The power used from this external 24VDC output reduces the internal system 24VDC that is available to the modules by an equal amount. When using the 24VDC output at the base terminal, it is recommended that 100mA not be exceeded.

Power Consumed				
Device	5V(mA)	9V(mA)	24V(mA)	Ext req.
CPUs		1	1	
D3-330 D3-340 D3-350	300 300 500	50 20 0	0 0 0	0 0 0
DC Input I	Aodules			
D3-08ND2 F3-16ND3F	0 0	10 148	112 68	0 0
AC Input N	lodules		_	
D3-08NA-1 D3-08NA-2 D3-16NA	0 0 0	10 10 100	0 0 0	0 0 0
AC/DC Inp	ut Module:	S		
D3-16NE3	0	130	0	0
DC Output	Modules			
D3-08TD1 D3-08TD2 D3-16TD1-1 D3-16TD2	0 0 0 0	20 30 40 180	24 0 96 0	0 0 0 0
AC Output	Modules			
F3-08TAS-1 D3-08TA-1 D3-08TA-2 F3-16TA-2 D3-16TA-2	0 0 0 0 0	200 160 160 250 400	0 0 0 0 0	0 0 0 0 0

Power Supplied						
Device	5V(mA)	9V(mA)	24V(mA)	24 V (mA)		
D3-05B-1 D3-08B-1 D3-10B-1 D3-05BDC D3-10BDC D3-05B-NR D3-05BDC-NR	900 900 900 900 900 900 900	2000 2000 2000 2000 2000 2000 2000 200	500 500 500 500 500 500 500	100 100 100 None None 100 None		
	F	Power Co	nsumed	_		
Device	5V(mA)	9V(mA)	24V(mA)	External required		
Relay Outpu	t Module.	S	1			
D3-08TR F3-08TRS-1 F3-08TRS-2 D3-16TR	0 0 0 0	360 296 296 480	0 0 0 0	0 0 0 0		
Analog Tem	perature a	and Thern	nocouple N	lodules		
F3-04ADS F3-08AD-1 F3-08THM-n F3-16AD F3-04DA-1 F3-04DAS	0 0 0 0 0 0	183 45 50 55 144 154	50 55 34 65 108 145	0 0 0 0 0 0		
Communica	tions and	Networki	ng	1		
D3-232 DCU D3-422 DCU	500 500	0 0	0	Optional 5V@500mA Optional 5V@500mA		
Specialty Modules						
D3-HSC D3-TCSU	0 40	70 5	0	0 0		
Programming						
D2-HPP	200	0	0	0		
Specialty CPUs						
F3-0MUX-1* F3-0MUX-2 F3-PMUX F3-RTU	409 262 455 416	0 0 0 0	0 150 0 0	0 0 0 0		
Operator Interface						
<i>C-more</i> Micro-Graphic	210	0	0	0		

* F3-OMUX-1 -As of 3/2021 CPU is no longer available from supplier.